

FUJITSU**CMOS 1,048,576 BIT
UV ERASABLE READ
ONLY MEMORY****MBM27C1028-15
MBM27C1028-20
MBM27C1028-25****CMOS 1,048,576 BIT UV ERASABLE READ ONLY
MEMORY (EPROM)**September 1988
Edition 1.0

The Fujitsu MBM27C1028 EPROM is a high speed read-only static memory that is UV-erasable and reprogrammable. The device contains 1,048,576 programmable or reprogrammable bits organized in a 131,072-byte/8 bit or 65,536-word/16-bit format. The MBM27C1028 has a multiplexed address and data pin which permits the device to reduce the number of pin-count for portable system where compact circuit layout is required. The MBM27C1028 can then be housed in a 28-pin DIP or a 32-pad LCC with a transparent lid; when the lid is properly exposed to an ultraviolet light source, a previously programmed bit pattern is erased in approximately 15-to-21 minutes. A new bit pattern can then be written into memory.

The MBM27C1028 EPROM is fabricated using CMOS double polysilicon gate technology with stacked single transistor gate cells. The MBM27C1028 is an excellent choice for system development work and in other applications where program changes are frequently necessary. Once programmed, the device requires only a single +5V power supply; the current requirements are exceptionally low in both the active and standby modes of operation.

- 65,536 word/16 bit organization with on chip decoding
- 16-bit or 8-bit organization capability using a control signal
- On-chip latches for address
- Easy and simple memory expansion via \overline{OE} pin
- Three-state output for word-OR capability
- TTL-compatible inputs/outputs
- Fast access time:
MBM27C1028-15 = 150ns (max.)
MBM27C1028-20 = 200ns (max.)
MBM27C1028-25 = 250ns (max.)
- Single +5V($\pm 10\%$) power supply with low current drain:
Active operation = 30mA (max)
Standby operation = 0.1mA (max)
- Programming voltage: +12.5V(± 0.3 V)
- Programming capability with Quick Pro™ algorithm
- No interface to be required to MBL8086 and MBL80168
- JEDEC approved pin assignments
- Standard package:
28-pin Ceramic (Cerdip) DIP Package : suffix = Z
32-pad Frit seal LCC Package : suffix = TV

ABSOLUTE MAXIMUM RATINGS (see NOTE)

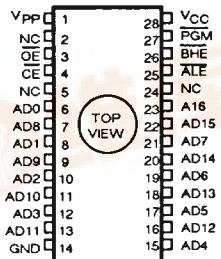
Rating	Symbol	Value	Unit
Supply Voltage with Respect to GND	V_{CC}	-0.6 to +7.0	V
V _{PP} Voltage with Respect to GND	V_{PP}	-0.6 to +14.0	V
All Inputs, I/Os Voltage with Respect to GND	$V_{IN}, V_{I/O}$	-0.6 to $V_{CC}+0.3$	V
Temperature under Bias	T_{BIAS}	-25 to +85	°C
Storage Temperature	T_{STG}	-65 to +125	°C

NOTE: Permanent device damage may occur if the above Absolute Maximum Ratings are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



CERAMIC PACKAGE
DIP-28C-C01

LCC-32C-F01 See Page 11

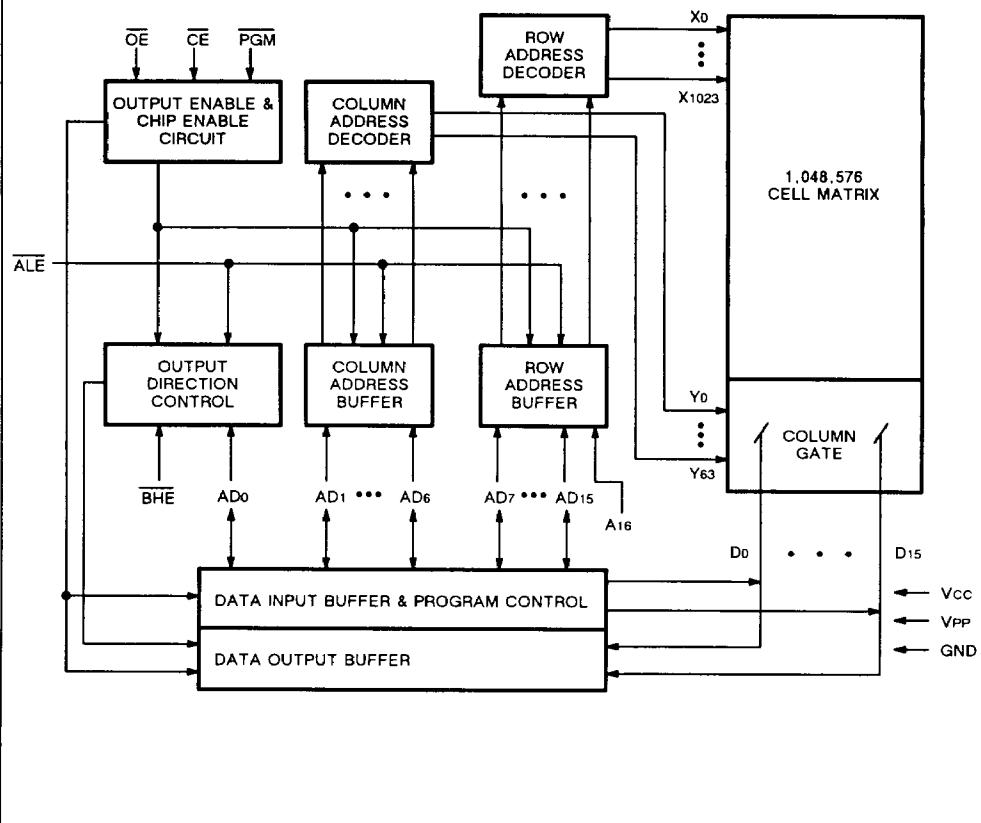
PIN ASSIGNMENT

LCC : See page 11

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields. However, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit.

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Fig. 1 — MBM27C1028 BLOCK DIAGRAM



CAPACITANCE ($T_A = 25^\circ\text{C}$, $f = 1\text{MHz}$)

Parameter	Symbol	Values			Unit
		Min	Typ	Max	
Input Capacitance ($V_{IN} = 0\text{V}$)	C_{IN}		6	8	pF
I/O Capacitance ($V_{I/O} = 0\text{V}$)	$C_{I/O}$		8	12	pF



PIN DESCRIPTION

Symbol	Pin No. (Pad No.)	Function
V _{PP}	1 (2)	+12.5V programming voltage
NC	2,5,24 (1,3,6,12,17,26,28)	No connection
<u>OE</u>	3 (4)	Output enable. When <u>OE</u> and <u>CE</u> are active low and the <u>PGM</u> strobe is active High; all proper output lines (Either "AD0 to AD15" or "AD0 to AD7" are enabled.
<u>CE</u>	4 (5)	Chip enable. When active low, the device is enabled for data read and programming operations.
AD ₀ to AD ₁₅	6-13,15-22 (7-11,13-15,18-25)	Address/Data. When <u>OE</u> is High, all ADs work as address input line. When Low, all ADs work as data output line.
GND	14 (16)	Circuit ground
A ₁₆	23 (27)	Address line (MSB)
ALE	25 (29)	Address latch enable. When CE is Low and ALE is High, the address from input buffer is transferred to address decoder by falling edge of ALE.
BHE	26 (30)	Bus high enable. When BHE is Low in conjunction with AD0, a word/16-bit data is available. When BHE is High, a byte/8-bit data is available.
<u>PGM</u>	27 (31)	Program Control/Output Enable. When active Low, programming data from the input buffer is written into a specified memory provided the following conditions are met: V _{PP} =12.5V; V _{CC} =5V, CE=ALE=Low; OE=High.
V _{CC}	28 (32)	+5V Power supply

FUNCTIONAL TRUTH TABLE

Mode \ Pin Name	AD ₀	AD ₁ - AD ₁₅	A ₁₆	ALE	BHE	CE	OE	PGM	V _{CC}	V _{PP}	GND
STANDBY	High-Z	High-Z	X ^{*1}	X	X	VIH	X	X	5V	5V	OV
READ ADDRESS LATCH	X ^{*2}	A _{IN}	A _{IN}	X	X ^{*2}	VIL	VIH	X	5V	5V	OV
READ	DOUT ^{*2}	DOUT ^{*2}	X	VIL	X	VIL	VIL	VIH	5V	5V	OV
OUTPUT DISABLE	High-Z	High-Z	X	VIL	X	VIL	VIH	X	5V	5V	OV
PROGRAM ADDRESS LATCH	VIL	A _{IN}	A _{IN}	X	VIL	VIL	VIH	VIH	6V	12.5V	OV
PROGRAM	DIN	DIN	X	VIL	X	VIL	VIH	VIL	6V	12.5V	OV
PROGRAM VERIFY	Dout	Dout	X	VIL	X	VIL	VIL	VIH	6V	12.5V	OV
PROGRAM INHIBIT	High-Z	High-Z	X	X	X	VIH	X	X	6V	12.5V	OV

Note *1: X can be either VIL or VIH.

*2: See below.

AD₀ and BHE should be basically used to enable for the lower and upper byte of the data, respectively. But when both AD₀ and BHE are high, it enables to transfer the upper byte data to lower byte bus, AD₀ to AD₇; thus, if BHE pulled High, the MBM27C1028 can be used for byte wide/8-bit memory, organized 128K words by 8 bit.

AD ₀	BHE	AD ₀ to AD ₇	AD ₈ to AD ₁₅
VIL	VIL	Do to D ₇	Do to D ₁₅
VIL	VIH	Do to D ₇	High-Z
VIH	VIL	High-Z	Do to D ₁₅
VIH	VIH	Do to D ₁₅	High-Z


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RECOMMENDED OPERATING CONDITIONS (Referenced to GND)

Parameter	Symbol	Value			Unit
		Min	Typ	Max	
V _{CC} Supply Voltage	V _{CC}	4.5	5.0	5.5	V
V _{PP} Supply Voltage	V _{PP}	V _{CC} -0.6	V _{CC}	V _{CC} +0.6	V
Operating Temperature	T _A	0		70	°C

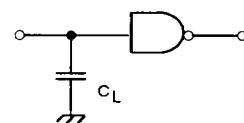
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DC CHARACTERISTICS (Recommended operating conditions unless otherwise noted)

Parameter	Symbol	Values			Unit
		Min	Typ	Max	
Input Load Current V _{IN} = 5.5V)	I _U			10	μA
Output Leakage Current (V _{OUT} =5.5V)	I _{LO}			10	μA
V _{PP} Supply Current	I _{PP1}		1	100	μA
V _{CC} Standby Current (CE = V _{IH})	I _{SB1}		0.3	1	mA
V _{CC} Standby Current (CE = V _{CC} +0.3V)	I _{SB2}		1	100	μA
V _{CC} Active Current (CE = V _{IL} , I _{OUT} = 0mA)	I _{CC1}		10	30	mA
V _{CC} Operation Current (f = 4MHz, I _{OUT} = 0mA)	I _{CC2}		8	30	mA
Input High Voltage	V _{IH}	2.0		V _{CC} +0.3	V
Input Low Voltage	V _{IL}	-0.1		0.8	V
Output Low Voltage (I _{OL} = 2.1mA)	V _{OL}			0.45	V
Output High Voltage (I _{OH} = -400 μA)	V _{OH1}	2.4			V
Output High Voltage (I _{OH} = -100 μA)	V _{OH2}	V _{CC} -0.7			V

Fig. 2 — AC TEST CONDITIONS (INCLUDING PROGRAMMING)

Input pulse levels: 0.45V TO 2.4V
 Input Rise and Fall Times: ≤20ns
 Timing Measurement Reference Levels: 0.8V and 2.0V for inputs
 0.8V and 2.0V for output
 Output Load: 1 TTL gate and C_L = 100pF



AC CHARACTERISTICS

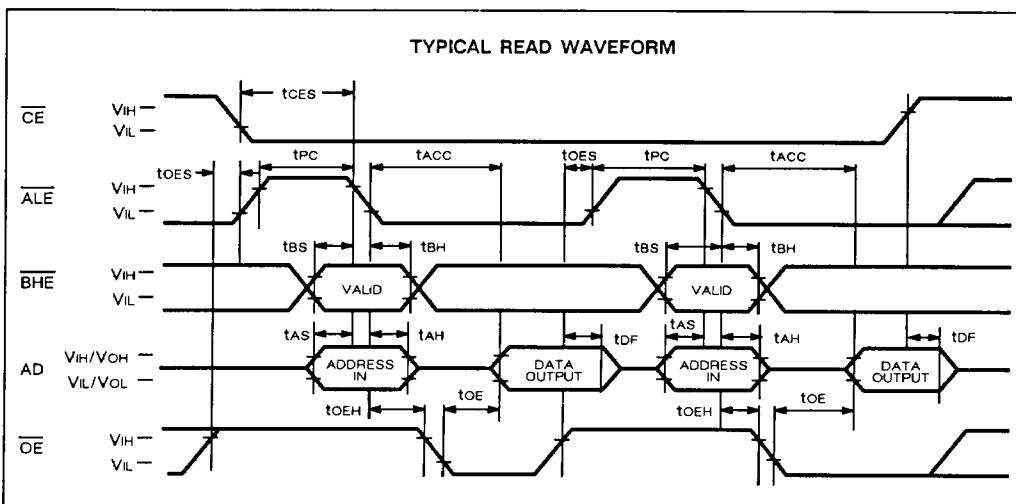
(Recommended operating conditions unless otherwise noted)

Parameter	Symbol	MBM27C1028-15			MBM27C1028-20			MBM27C1028-25			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
ALE Active to Output Valid (CE=OE=V _{IL} , PGM=V _{IH})	t _{ACC}			150			200			250	ns
ALE Precharge Time (CE=V _{IL})	t _{PC}	60			75			100			ns
CE Setup Time	t _{CES}	60			75			100			ns
Address Setup Time	t _{AS}	20			25			30			ns
Address Hold Time	t _{AH}	20			25			30			ns
BHE Setup Time	t _{BS}	20			25			30			ns
BHE Hold Time	t _{BH}	20			25			30			ns
OE Setup Time	t _{OES}	0			0			0			ns
OE Hold Time	t _{OEH}	20			25			30			ns
OE to Output Valid* ¹ (PGM=V _{IH})	t _{OE}	0		70	0		70	0		100	ns
PGM to Output Valid* ¹ (OE=V _{IL})	t _{PGM}	0		70	0		70	0		100	ns
Output Disable to Output Float* ³	t _{DF}	0		60	0		60	0		60	ns

NOTE: *¹ OE (PGM) may be delayed up to t_{ACC}-t_{OE}(t_{PGM}) after the falling edge of ALE.

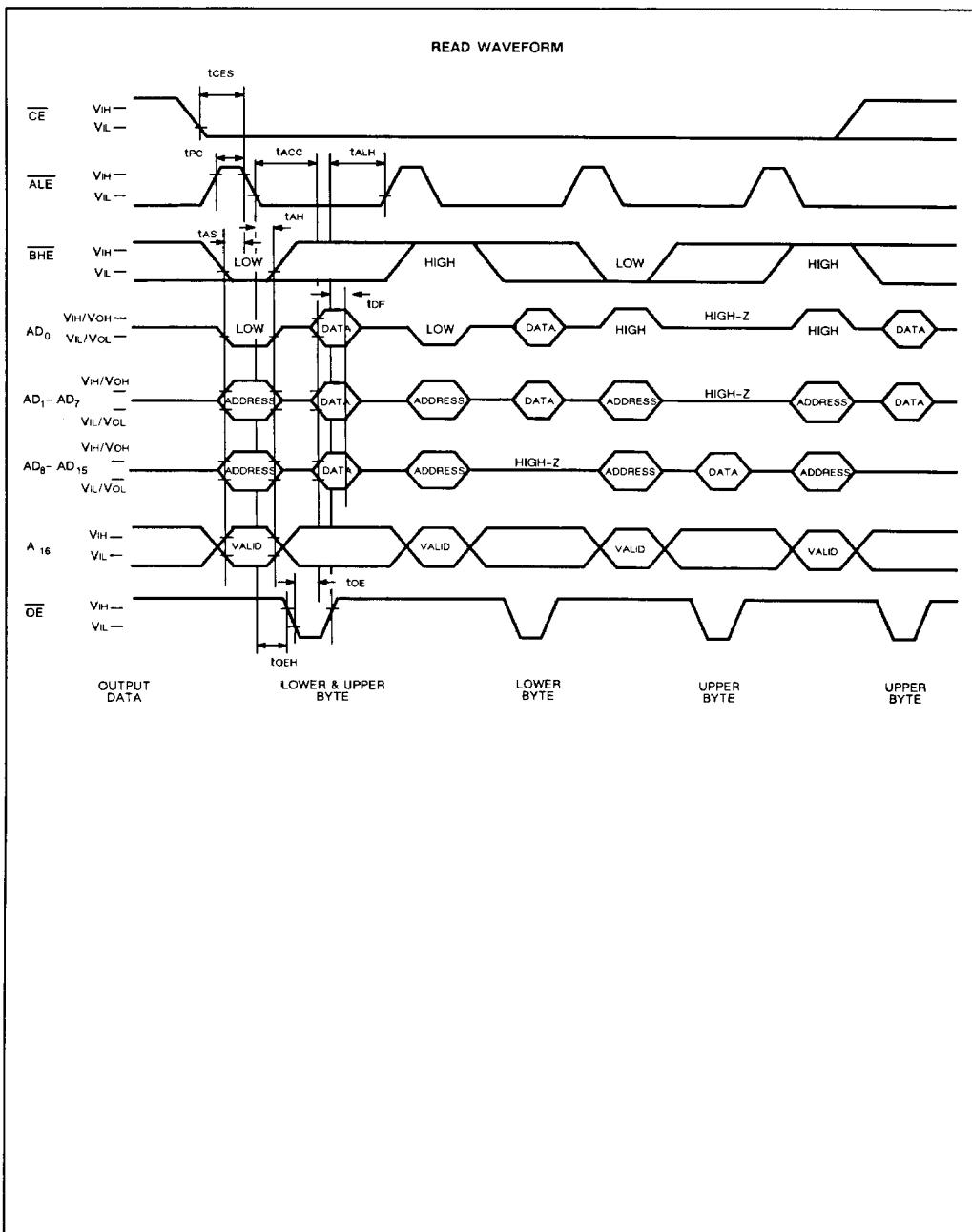
*² tDF is specified from CE, OE or PGM or ALE, whichever occurs first.

Output Float is defined as the point where data is no longer driven.



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PROGRAMMING / ERASING INFORMATION

PROGRAMMING

When the MBM27C1028 is shipped the factory, all memory cells (1,048,576 bits) are set to High state (logic 1). During the programming procedure, affected bit cells are set to the Low state (logic 0).

The MBM27C1028 is programmed with a fast programming algorithm design by Fujitsu called Quick Pro™. When +12.5V($\pm 0.3V$) is applied to V_{PP} , +6V($\pm 0.25V$) is applied to V_{CC} , $\overline{CE} = V_{IL}$, $\overline{PGM} = V_{IH}$, the programming mode is initiated. Next, the proper address in conjunction with \overline{BHE} are input by falling edge of \overline{ALE} , and the data pattern is applied to the input buffer (Figure1). When both address (and \overline{BHE}) and data are stable, a 0.5ms negative pulse is applied to the \overline{PGM} . Upon verification of written data read out by \overline{OE} an over pulse (three times the initial pulse width times the number of pulses used to accomplish a write) should be applied to complete the programming of one byte. Refer to the PROGRAMMING FLOWCHART that follows for step-by-step programming procedures.

Caution

The width of one programming pulse must not exceed 40ms; thus, a continuous TTL low-level voltage should not be applied

to the \overline{PGM} . Also, a $0.1\mu F$ capacitor must be connected between V_{PP} and ground to prevent excessive voltage transients. Neglecting either of these precautions may cause device failure.

ERASING

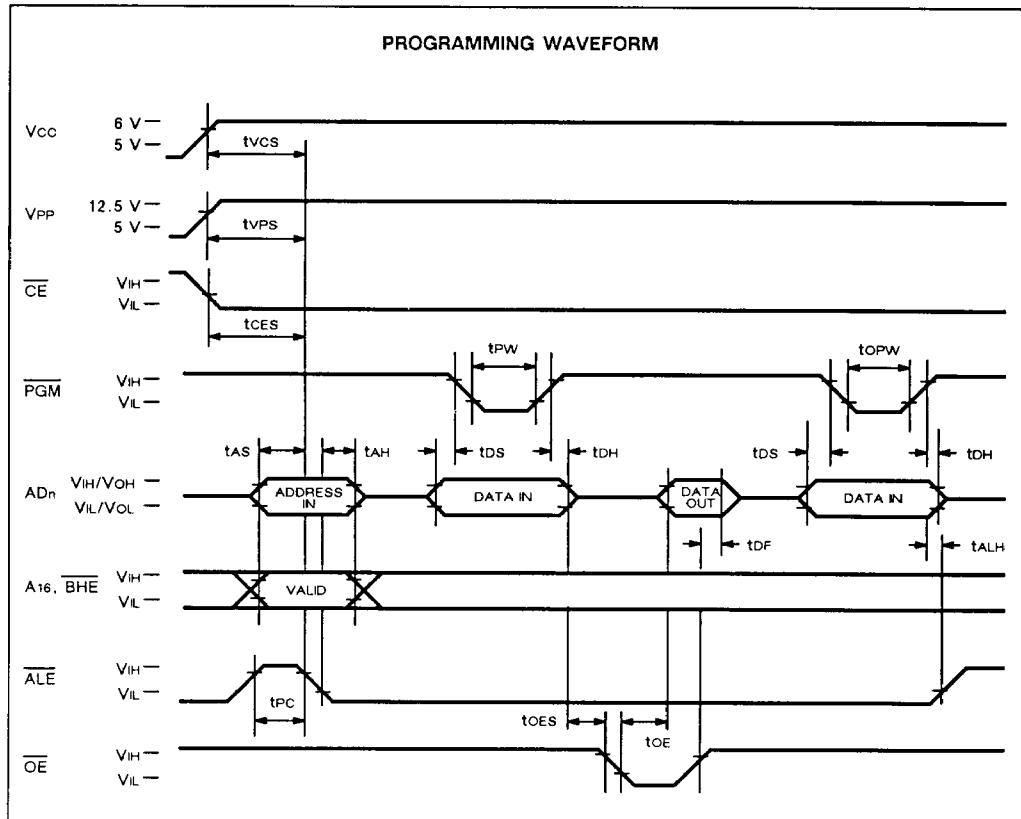
In order to clear all memory cells of programmed contents, the MBM27C1028 must be exposed to an ultraviolet light source. To completely erase the memory (restore all cells to a logic 1 state), a dosage of $15Wsec/cm^2$ is required. The required exposure can be obtained by using a UV-lamp with a wavelength of 253.7nm with an intensity of $12mW/cm^2$. Remove all filters from the lamp and clean the transparent lid of the MBM27C1028 with a non-abrasive cleaner. Hold the MBM27C1028 approximately one inch from the light source for 15-to-21 minute. (Note. The MBM27C1028 and other similar devices can be erased by light sources with longer wavelength; however, the erasing time is much greater. Nonetheless, exposure to fluorescents or sunlight will severely degrade and eventually erase the memory. When used in a lighted environment, it is recommended that the transparent window be covered with an opaque label.)



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PROGRAMMING / ERASING INFORMATION (Cont'd)



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DC CHARACTERISTICS DURING PROGRAMMING

($T_A = 25^\circ C \pm 5^\circ C$, $V_{CC} = 6V \pm 0.25V$, $V_{PP} = 12.5V \pm 0.3V$)

Parameter	Symbol	Min	Typ	Max	Unit
Input High Level	V_{IH}	2.0		$V_{CC} + 0.3$	V
Input Low Level	V_{IL}	-0.1		0.8	V
Input Load Current	I_{LI}	-10		10	μA
V_{CC} Supply Current ($\overline{CE} = V_{IH}$)	I_{SB^3}			1	mA
V_{CC} Supply Current ($\overline{CE} = V_{CC} \pm 0.3V$)	I_{SB^4}		1	100	μA
V_{PP} Supply Current ($CE = V_{IL}$)	I_{CC^3}			30	mA
V_{PP} Supply Current ($CE = PGM = V_{IL}$, $OE = V_{IH}$)	I_{PP^2}			50	mA
V_{PP} Supply Current ($PGM = V_{IH}$)	I_{PP^3}			5	mA
Output Low Level ($I_{OL} = 2.1mA$)	V_{OL}			0.45	V
Output High Level ($I_{OH} = -400 \mu A$)	V_{OH}	2.4			V

AC CHARACTERISTICS DURING PROGRAMMING

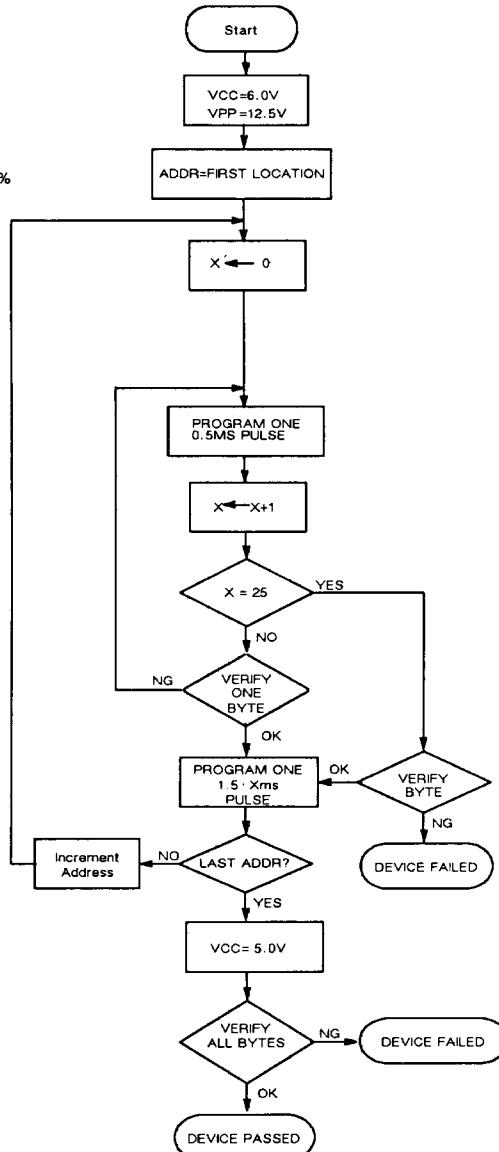
($T_A = 25^\circ C \pm 5^\circ C$, $V_{CC} = 6V \pm 0.25V$, $V_{PP} = 12.5V \pm 0.3V$)

Parameter	Symbol	Values			Unit
		Min	Typ	Max	
V_{CC} Setup Time	t_{VCS}	4			μs
V_{PP} Setup Time	t_{VPS}	4			μs
\overline{CE} Setup Time	t_{CES}	4			μs
Address Setup Time	t_{AS}	1			μs
Address Hold Time	t_{AH}	1			μs
ALE Precharge Time	t_{PC}	2			μs
ALE Low Hold Time	t_{ALH}	2			μs
Data Setup Time	t_{DS}	2			μs
Data Hold Time	t_{DH}	2			μs
OE Setup Time	t_{OES}	2			μs
\overline{OE} to Output Valid	t_{OE}			100	ns
\overline{OE} to Output Float	t_{DF}			60	ns
Programming Pulse Width	t_{PW}	0.475	0.50	0.525	ms
Over Programming Pulse Number	n	1		25	times

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Fig. 3 — PROGRAMMING CHART

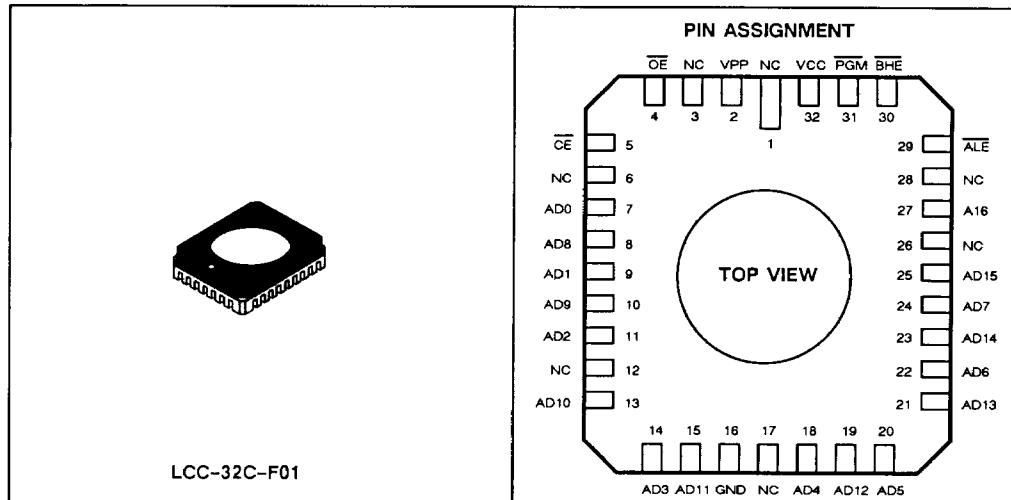
V_{CC}=6V ± 0.25V
V_{PP}=12.5V ± 0.3V
t_{PW}=0.5ms ± 5%
t_{OPN}=1.5xNms ± 5%



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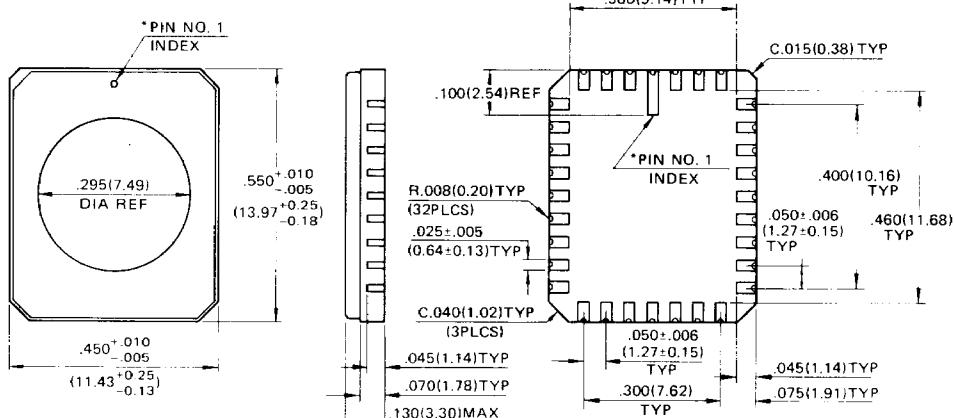
PACKAGE DIMENSIONS



LCC-32C-F01

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32-PAD CERAMIC (FRIT SEAL) LEADLESS CHIP CARRIER
 (Case No.: LCC-32C-F01)



*Shape of PIN NO.1 INDEX. Subject to change without notice.

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Dimension in inches
 and (millimeters)

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PACKAGE DIMENSIONS

28-PIN CERAMIC DUAL IN-LINE PACKAGE
(Case No.: DIP-28C-C01)

